502025819 08/15/2012

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Ho Young SON	07/16/2012

RECEIVING PARTY DATA

Name:	SK hynix Inc.	
Street Address:	2091, Gyeongchung-daero, Bubal-eub	
City:	Icheon-si Gyeonggi-do	
State/Country:	KOREA, REPUBLIC OF	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13586199

CORRESPONDENCE DATA

Fax Number: 6309087653 Phone: 630 908 7652

Email: uspto.actions@wwplaw.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

via US Mail.

Correspondent Name: William Park & Associates LTD.

Address Line 1: 930 N. York Road, Suite 201

Address Line 4: Hinsdale, ILLINOIS 60521

ATTORNEY DOCKET NUMBER:	PA0543-0	
NAME OF SUBMITTER:	Woochoon W. Park	

Total Attachments: 2

source=PA0543-0_Assignment#page1.tif source=PA0543-0_Assignment#page2.tif

OP \$40.00 13

PATENT REEL: 028790 FRAME: 0878 DOCKET: PATENT

ASSIGNMENT OF APPLICATION

Now, therefore, in consideration of the sum of one dollar (\$1), the receipt whereof is acknowledge, and other good and valuable consideration, I/We, the assignor(s)

ASSIGNOR(S)

Ho Young, SON

#206-1403, Jungang Heights Ville, Gak-ri, Ochang-myeon, Cheongwon-gun, Chungcheongbuk-do, Korea

by these presents do sell, assign and transfer unto said assignee

ASSINGEE

SK hynix Inc. 2091, Gyeongchung-daero, Bubal-eub, Icheon-si, Gyeonggi-do, Korea

and the heirs, successors, assigns and legal representatives of the assignee the full and exclusive right to the said invention in the United States which are disclosed in the U.S. patent application titled

SEMICONDUCTOR PACKAGE AND METHOD FOR MANUFACTURING THE SMAE!

for which an application for Number	a United States or	Patent was filed on	Application
for which an application for	a United States	Patent was executed by the	undersigned on

and any and all improvements thereof, the entire rights, title and interest in and to any and all Patents which may be granted therefore in the United States. I/We hereby authorize and request the Director of the U.S. Patent and Trademark Office to issue said United States Patent to said assignee, of the entire right, title, and interest in and to the same, for his sole use and for the use of his legal representatives, to the full end of the term for which said Patent may be granted, as fully and entirely as the same would have been held by me had this assignment and sale not been made.

The assignor(s) agree promptly upon request of the Assignee, its heirs, successors, assigns and legal representatives of the assignee to communicate any facts known to it respecting the patent and the invention set forth therein, and to execute and deliver without further compensation any power of attorney. Assignment, application, whether original, continuation, divisional or reissue, or other papers that may be necessary or fully

Assignor(s) hereby covenants that no assignment, sale agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

Assignor(s) further covenants that assignee will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to Assignor(s) and will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to assignee or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

Page 1 of 2



B50319/10.18A15202/2012-07-16 15:41 **REEL: 028790 FRAME: 0879**

DOCKET:

PATENT

ASSIGNOR SIGNATURE(S)

Ho Young Son

01/16/74/2 Date

Page 2 of 2